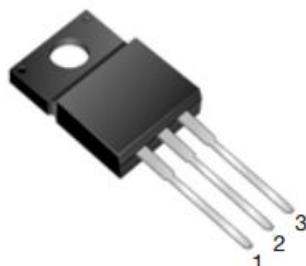


## MBRF20200CT (CTR) SCHOTTKY RECTIFIER

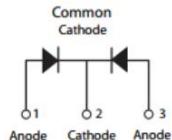


ITO-220AB

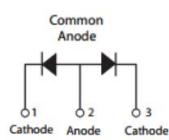
### Features

- 175°C  $T_j$  operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### Circuit Diagram



MBRF20200CT



MBRF20200CTR

### Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

### Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage	$V_{RRM}$		200	V
Working Peak Reverse Voltage	$V_{RWM}$			
DC Blocking Voltage	$V_R$			
Average Rectified Forward Current	$I_{F(AV)}$	50% duty cycle @ $T_c=105^\circ\text{C}$ , rectangular wave form	10(Per Leg) 20(Per Device)	A
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	$I_{FSM}$	8.3ms, Half Sine pulse	150	A

### Electrical Characteristics:

Characteristics	Symbol	Condition	Typ.	Max.	Units
Forward Voltage Drop(Per Leg)*	$V_{F1}$	@10A, Pulse, $T_j = 25^\circ\text{C}$	0.85	0.95	V
	$V_{F2}$	@10A, Pulse, $T_j = 125^\circ\text{C}$	0.75	0.85	V
Reverse Current(Per Leg)*	$I_{R1}$	@ $V_R$ = rated $V_R$ , $T_j = 25^\circ\text{C}$	0.001	1.0	mA
	$I_{R2}$	@ $V_R$ = rated $V_R$ , $T_j = 125^\circ\text{C}$	0.03	50	mA
Junction Capacitance(Per Leg)	$C_T$	@ $V_R = 5V$ , $T_c = 25^\circ\text{C}$ , $f_{SIG} = 1\text{MHz}$	110	300	pF
Series Inductance(Per Leg)	$L_S$	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	$dv/dt$	-	-	10,000	V/ $\mu$ s
RSM Isolation Voltage ( $t = 1.0$ second, R. H. $\leq 30\%$ , $T_A = 25^\circ\text{C}$ )	$V_{ISO}$	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction.	-	4500	V
		Clip mounting, the epoxy body is inside the heatsink.	-	3500	
		Screw mounting, the epoxy body is inside the heatsink.	-	1500	

\* Pulse width  $< 300\text{ }\mu\text{s}$ , duty cycle  $< 2\%$

## Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	$T_J$	-	-55 to +175	°C
Storage Temperature	$T_{stg}$	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	$R_{\theta JC}$	DC operation	4.5	°C/W
Approximate Weight	wt	-	2	g
Case Style			ITO-220AB	

## Ratings and Characteristics Curves

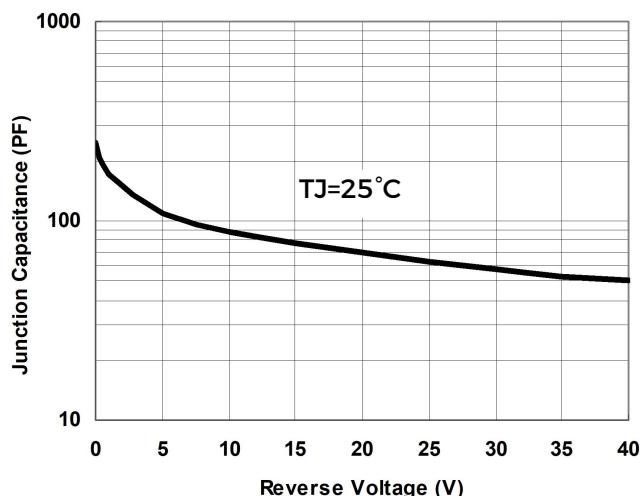


Fig.1-Typical Junction Capacitance

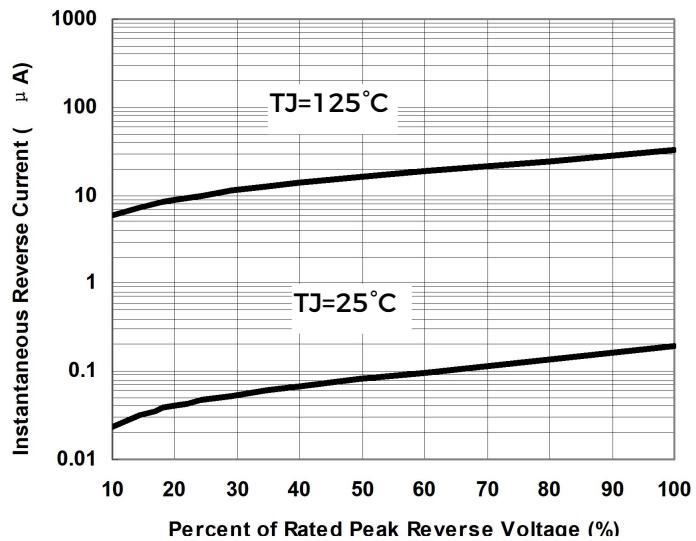


Fig.2-Typical Reverse Characteristics

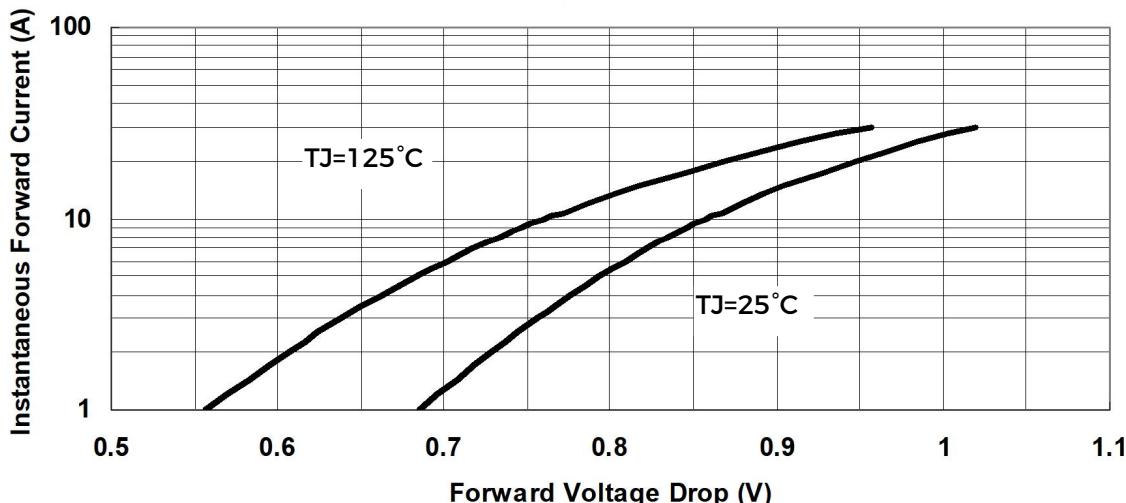
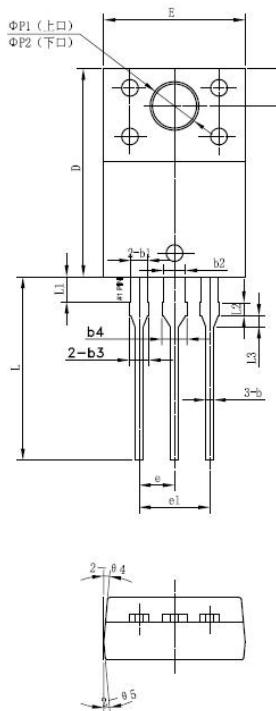


Fig.3-Typical Instantaneous Forward Voltage Characteristics

## Mechanical Dimensions ITO-220AB



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